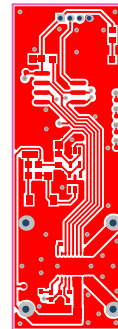


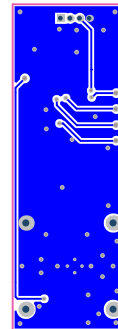
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 6/8/2015	2:25:33 PM	TEXAS INSTRUMENTS



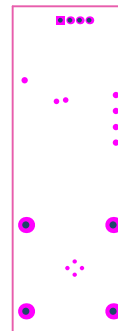
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 6/8/2015 2:25:34 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 6/8/2015 2:25:35 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 6/8/2015 2:25:35 PM	TEXAS INSTRUMENTS	

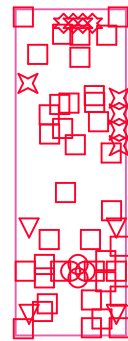


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 6/8/2015 2:25:36 PM	TEXAS INSTRUMENTS	

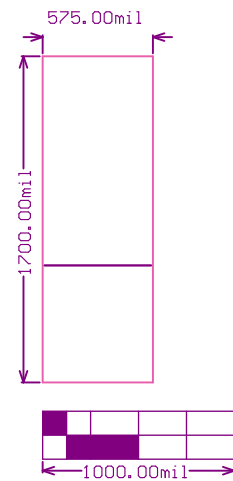
TIDA-00602  
EOL verification complete. All ECC addresses for use are present.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 6/8/2015 2:25:37 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	4	7.87mil (0.200mm)	PTH	Round
□	38	15.00mil (0.381mm)	PTH	Round
⊠	5	20.00mil (0.508mm)	PTH	Round
☆	4	25.59mil (0.650mm)	PTH	Round
▽	4	37.99mil (0.965mm)	PTH	Round
	55 Total			



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 6/8/2015	2:25:38 PM	TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00602	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 6/8/2015	2:25:39 PM	TEXAS INSTRUMENTS



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